| ABSOCIATION CONNECTING<br>ELECTRANCE INDUSTRIES   | ockburn. Illinois. A  | ll rights reserved untions. | inder both | This docume<br>level parts, t | ent is a declarat<br>he declaration e                            | ion of the su | ubstances<br>s all lowe | within the ma<br>r level materi | anufacturer<br>als for whic           | listed item. N<br>ch the manufa | ote: if th | e item is an as<br>s engineering | sembly with lower responsibility. |
|---|---|-----------------------------|------------|-------------------------------|--|---------------|-------------------------|---------------------------------|---------------------------------------|---------------------------------|------------|----------------------------------|-----------------------------------|
|   | 21.1 IPC Web Site for Information on IPC-1752 Standard Form Typ<br>http://www.ipc.org/IPC-175x Distribute |                             |            |                               | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |               |                         |                                 |                                       | als and Mfg Information         |            |                                  |                                   |
| Supplier Information                              |   |                             |            |                               |  |               |                         |                                 |                                       |                                 |            |                                  |                                   |
| Company name* Company unique ID                   |   |                             |            | Unique ID Authority           |  |               |                         |                                 | F                                     | Response Date*                  |            |                                  |                                   |
| onsemi  | semi  |                             |            |                               |  |               |                         |                                 | 2                                     | 2023-06-08                      |            |                                  |                                   |
| Contact Name                                      | Title - Contact   |                             |            | ]                             | Phone - Contact*   |               |                         |                                 | F                                     | Email - Contact*                |            |                                  |                                   |
| Product-Env-Stewards                              | uct-Env-Stewards Product Enviro Compliance  |                             |            |                               | NA   |               |                         |                                 | ]                                     | Product-Env-Stewards@onsemi.com |            |                                  |                                   |
| Authorized Representative* Title - Representative |   |                             |            | Phone - Representative*       |  |               |                         | E                               | Email - Representative*               |                                 |            |                                  |                                   |
| Product-Env-Stewards Product Enviro Compliance    |   |                             |            | NA                            |  |               |                         |                                 | Product-Env-Stewards@onsemi.com       |                                 |            |                                  |                                   |
| Requester Item Number Mfr                         | Item Number   | Mfr Item Name               |            |                               | Effective Date   | Version       | I                       | Manufacturing Site              |                                       | Weigh                           | t*         | UOM                              | Unit Type                         |
| NCI   | P5661MN30T2G ANA 1A LDO REGU  |                             | EGULATOR   |                               | 2023-06-08   |               | MY1                     |                                 |                                       | 23.36                           |            | mg                               | Each                              |
| Manufacturing Proccess Information                |   |                             |            |                               |  |               | <b>I</b>                |                                 |                                       |                                 |            |                                  |                                   |
| Terminal Plating / Grid Array Material            | Terminal Base Alloy J-STD-020 M   |                             |            | Rating                        | Peak Process Body Temperature Max Time at Pea                    |               |                         | e at Peak Te                    | k Temperature Number of Reflow Cycles |                                 |            |                                  |                                   |
| Matte Tin (Sn) - annealed CU Alloy 1              |   | 1                           |            | 260                           |  | С             | 30                      |                                 | seconds                               | 3                               |            |                                  |                                   |
| Comments  |   |                             |            |                               |  |               |                         |                                 |                                       |                                 |            |                                  |                                   |
| evel 1 - maximum time at peak temperature durin   | g soldering is 10-3   | 0 seconds                   |            |                               |  |               |                         |                                 |                                       |                                 |            |                                  |                                   |
| For more information regarding material composi   | tion please refer to  | page 3                      |            |                               |  |               |                         |                                 |                                       |                                 |            |                                  |                                   |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless otherwise noted). |        |                 |          |  |                  |        |        |                 |  |
|--|--------|-----------------|----------|--|------------------|--------|--------|-----------------|--|
| Homogeneous Material                                 | Weight | Unit of Measure | Level    | Substance  | CAS              | Exempt | Weight | Unit of Measure |  |
| Die  | 0.99   | mg              | Supplier | Silicon (Si)   | 7440-21-3        |        | 0.99   | mg              |  |
| Die Attach   | 0.24   | mg              | Supplier | Epoxized Condensate Of Para-<br>Hydrobenzaldehyde And Alkyl Phenol | 129915-35-1      |        | 0.0768 | mg              |  |
|  |        |                 | Supplier | Aluminum Trioxide (Al2O3)  | 1344-28-1        |        | 0.1632 | mg              |  |
| Lead Frame 5   | 5.9    | mg              | Supplier | Silver (Ag)  | 7440-22-4        |        | 0.118  | mg              |  |
|  |        |                 | Supplier | Iron (Fe)  | 7439-89-6        |        | 0.1298 | mg              |  |
|  |        |                 | Supplier | Copper (Cu)  | 7440-50-8        |        | 5.6522 | mg              |  |
| Mold Compound-Black                                  | 14.8   | mg              |          | Epoxy Phenol Resin   | proprietary data |        | 1.332  | mg              |  |
|  |        |                 | Supplier | Fused Silica (SiO2)  | 60676-86-0       |        | 13.468 | mg              |  |
| Plating  | 1.22   | mg              | Supplier | Tin (Sn)   | 7440-31-5        |        | 1.22   | mg              |  |
| Wire Bond - Au                                       | 0.21   | mg              | Supplier | Gold (Au)  | 7440-57-5        |        | 0.21   | mg              |  |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted)